

N-Channel Super Junction Power MOSFET

General Description

The series of devices use advanced super junction technology and design to provide excellent R_{DS(ON)} with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

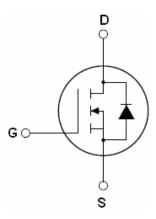
| Features | atures |
|----------|--------|
|----------|--------|

- New technology for high voltage device
- ●Low on-resistance and low conduction losses
- Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested

Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)

| V _{DS} @T _{jmax} | 650 | V |
|------------------------------------|-----|----|
| R _{DS(ON)} | 900 | mΩ |
| I_D | 5 | A |

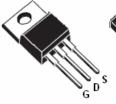


Schematic diagram

Package Marking And Ordering Information

| Device | Device Package | Marking |
|-----------|----------------|-----------|
| NCE05N60D | TO-263 | NCE05N60D |
| NCE05N60 | TO-220 | NCE05N60 |
| NCE05N60F | TO-220F | NCE05N60F |







TO-263

TO-220

TO-220F

Table 1. Absolute Maximum Ratings ($T_c=25^{\circ}$ C)

| Parameter | Symbol | NCE05N60 NCE05N60D | NCE05N60F | Unit |
|---|-------------------------|-----------------------|-----------|------|
| Drain-Source Voltage (V _{GS} =0V) | V _{DS} | 60 | 00 | V |
| Gate-Source Voltage (VDS=0V) | V _G S | 土 | 30 | V |
| Continuous Drain Current at Tc=25°C | I _{D (DC)} | 5 | 5* | А |
| Continuous Drain Current at Tc=100°C | I _{D (DC)} | 3 | 3* | А |
| Pulsed drain current (Note 1) | I _{DM (pluse)} | 15 | 15 | А |
| Drain Source voltage slope, VDS = 480 V, ID = 5 A, Tj = $125 ^{\circ}\text{C}$ | dv/dt | 50 | | V/ns |
| Maximum Power Dissipation(Tc=25°C) | P _D | 50 | 31 | W |
| Derate above 25°C | | 0.4 | 0.25 | w/°C |
| Single pulse avalanche energy (Note2) | Eas | 10 | 30 | mJ |
| Avalanche current ^(Note 1) | I _{AR} | ţ | 5 | А |



| Parameter | Symbol | Value | Unit |
|---|------------------|---------|------|
| Repetitive Avalanche energy , t_{AR} limited by T_{jmax} (Note 1) | E _{AR} | 0.4 | mJ |
| Operating Junction and Storage Temperature Range | T_{J}, T_{STG} | -55+150 | °C |

^{*} limited by maximum junction temperature

Table 2. Thermal Characteristic

| Parameter | Symbol | NCE05N60 NCE05N60D | NCE05N60F | Unit |
|---|-------------------|-----------------------|-----------|-------|
| Thermal Resistance, Junction-to-Case (Maximum) | R _{thJC} | 2.5 | 4 | °C /W |
| Thermal Resistance, Junction-to-Ambient (Maximum) | R _{thJA} | 62 | 80 | °C /W |

Table 3. Electrical Characteristics (TA=25℃unless otherwise noted)

| Parameter | Symbol | Condition | Min | Тур | Max | Unit |
|--|---------------------|---|-----|-----|------|------|
| On/off states | | | • | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V I _D =250μA | 600 | | | V |
| Zero Gate Voltage Drain Current(Tc=25℃) | I _{DSS} | V _{DS} =600V,V _{GS} =0V | | | 1 | μΑ |
| Zero Gate Voltage Drain Current(Tc=125℃) | I _{DSS} | V _{DS} =600V,V _{GS} =0V | | | 50 | μΑ |
| Gate-Body Leakage Current | I _{GSS} | V _{GS} =±30V,V _{DS} =0V | | | ±100 | nA |
| Gate Threshold Voltage | V _{GS(th)} | V _{DS} =V _{GS} ,I _D =250μA | 2.5 | 3 | 3.5 | V |
| Drain-Source On-State Resistance | R _{DS(ON)} | V _{GS} =10V, I _D =3A | | 850 | 900 | mΩ |
| Dynamic Characteristics | | | • | | | |
| Forward Transconductance | g FS | V _{DS} = 20V, I _D = 3A | | 5 | | S |
| Input Capacitance | C _{lss} | \/ -50\/\/ -0\/ | | 520 | | pF |
| Output Capacitance | C _{oss} | V_{DS} =50V, V_{GS} =0V, F=1.0MHz | | 52 | | pF |
| Reverse Transfer Capacitance | C _{rss} | F=1.UMHZ | | 4.5 | | pF |
| Total Gate Charge | Q_g | V _{DS} =480V,I _D =5A, V _{GS} =10V | | 12 | 25 | nC |
| Gate-Source Charge | Q_{gs} | | | 2.2 | | nC |
| Gate-Drain Charge | Q_{gd} | | | 4.5 | | nC |
| Intrinsic gate resistance | R _G | f = 1 MHz open drain | | 2.6 | | Ω |
| Switching times | | | • | | | |
| Turn-on Delay Time | $t_{d(on)}$ | | | 6 | | nS |
| Turn-on Rise Time | t _r | V_{DD} =380 V , I_{D} =5 A , | | 2.5 | | nS |
| Turn-Off Delay Time | $t_{d(off)}$ | R_G =18 Ω , V_{GS} =10 V | | 55 | 80 | nS |
| Turn-Off Fall Time | t _f | | | 9 | 14 | nS |
| Source- Drain Diode Characteristics | - | | • | | • | • |
| Source-drain current(Body Diode) | I _{SD} | T -25°C | | | 5 | Α |
| Pulsed Source-drain current(Body Diode) | I _{SDM} | - T _C =25°C | | | 15 | Α |
| Forward on voltage | V _{SD} | Tj=25°C,I _{SD} =5A,V _{GS} =0V | | 1 | 1.3 | V |
| Reverse Recovery Time | t _{rr} | | | 200 | | nS |
| Reverse Recovery Charge | Q _{rr} | Tj=25°C,I _F =5A,di/dt=100A/µs | | 1.6 | | uC |
| Peak reverse recovery current | I _{rrm} | | | 15 | | Α |

 ${\bf Notes: 1. Repetitive \ Rating: Pulse \ width \ limited \ by \ maximum \ junction \ temperature}$

^{2.} Tj=25°C,VDD=50V,VG=10V, R_G =25 Ω



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 1. Safe operating area

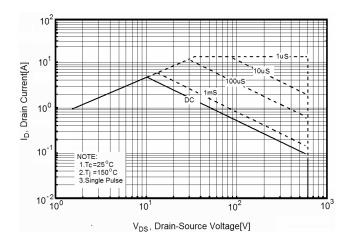


Figure 2. Safe operating area for NCE05N60F

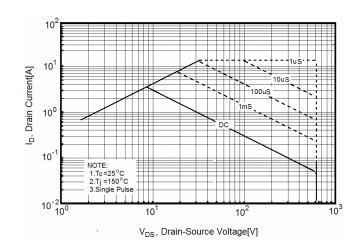


Figure 3. Source-Drain Diode Forward Voltage

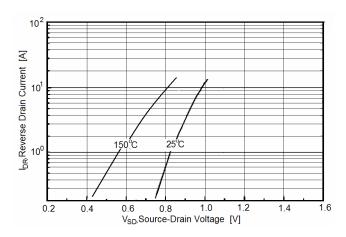


Figure 4. Output characteristics

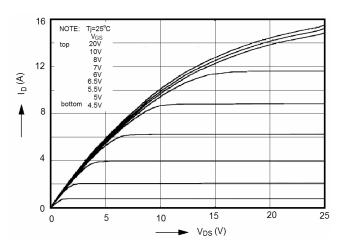


Figure 5. Transfer characteristics

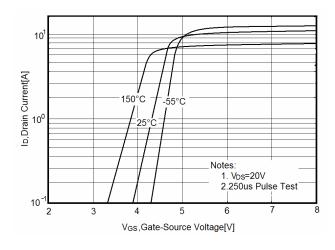


Figure 6. Static drain-source on resistance

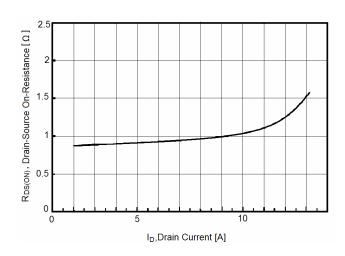




Figure 7. R_{DS(ON)} vs Junction Temperature

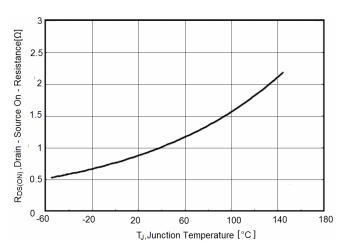


Figure 9. Maximum I_{D} vs Junction Temperature

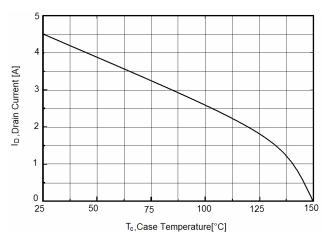
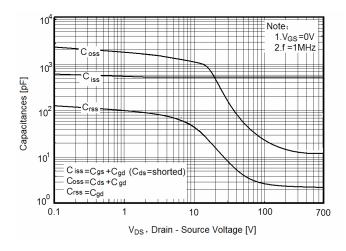


Figure 11. Capacitance



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Figure8. BV_{DSS} vs Junction Temperature

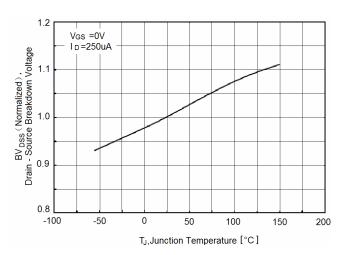


Figure 10. Gate charge waveforms

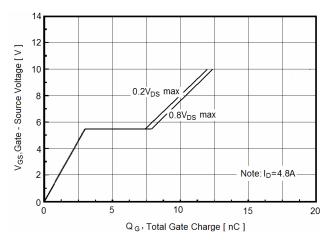


Figure 12. Transient Thermal Impedance

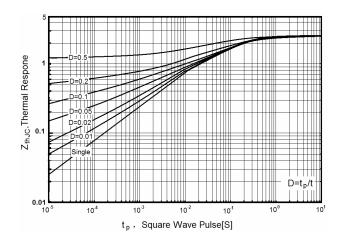
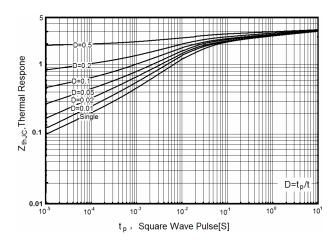




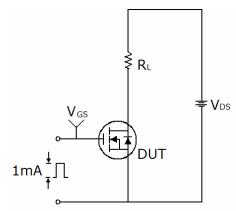
Figure 13. Transient Thermal Impedance for NCE05N60F

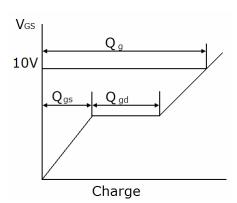




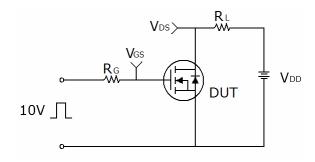
Test circuit

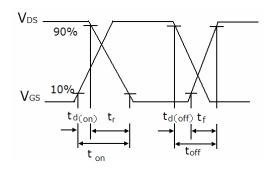
1) Gate charge test circuit & Waveform



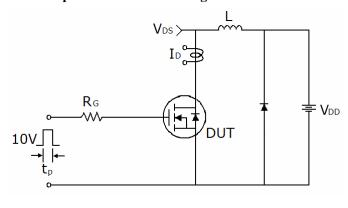


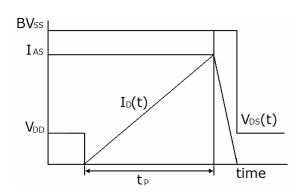
2) Switch Time Test Circuit:





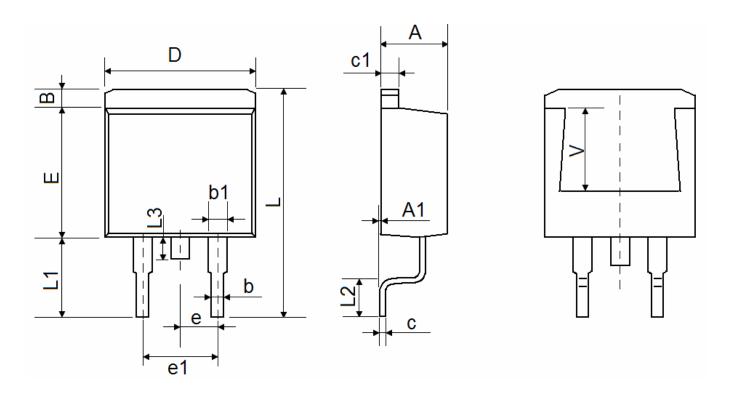
3) Unclamped Inductive Switching Test Circuit & Waveforms







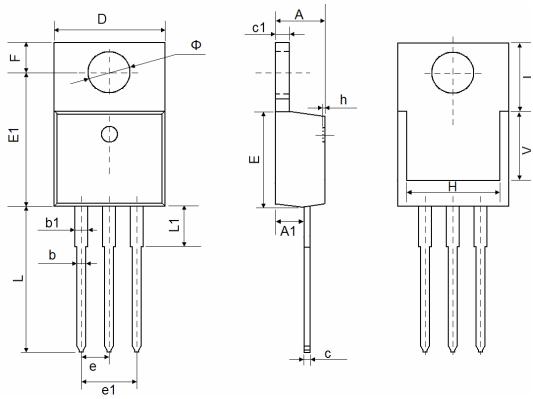
TO-263-2L Package Information



| Complete | Dimensions | In Millimeters | Dimensions | s In Inches |
|----------|------------|----------------|------------|-------------|
| Symbol | Min. | Max. | Min. | Max. |
| Α | 4.470 | 4.670 | 0.176 | 0.184 |
| A1 | 0.000 | 0.150 | 0.000 | 0.006 |
| В | 1.170 | 1.370 | 0.046 | 0.054 |
| b | 0.710 | 0.910 | 0.028 | 0.036 |
| b1 | 1.170 | 1.370 | 0.046 | 0.054 |
| С | 0.310 | 0.530 | 0.012 | 0.021 |
| c1 | 1.170 | 1.370 | 0.046 | 0.054 |
| D | 10.010 | 10.310 | 0.394 | 0.406 |
| Е | 8.500 | 8.900 | 0.335 | 0.350 |
| е | 2.540 | TYP. | 0.100 | TYP. |
| e1 | 4.980 | 5.180 | 0.196 | 0.204 |
| L | 15.050 | 15.450 | 0.593 | 0.608 |
| L1 | 5.080 | 5.480 | 0.200 | 0.216 |
| L2 | 2.340 | 2.740 | 0.092 | 0.108 |
| L3 | 1.300 | 1.700 | 0.051 | 0.067 |
| V | 5.600 | REF | 0.220 | REF |



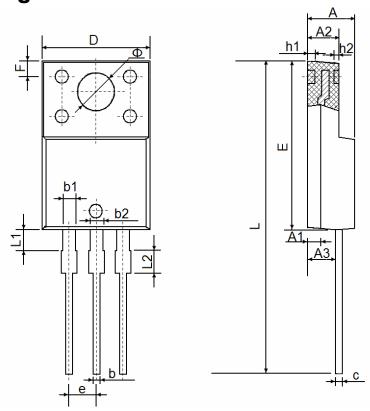
TO-220-3L Package Information



| Cymbal | Dimensions | In Millimeters | Dimension | s In Inches |
|--------|--------------|----------------|-----------|-------------|
| Symbol | Min. | Max. | Min. | Max. |
| A | 4.470 | 4.670 | 0.176 | 0.184 |
| A1 | 2.520 | 2.820 | 0.099 | 0.111 |
| b | 0.710 | 0.910 | 0.028 | 0.036 |
| b1 | 1.170 | 1.370 | 0.046 | 0.054 |
| С | 0.330 | 0.650 | 0.013 | 0.026 |
| c1 | 1.200 | 1.400 | 0.047 | 0.055 |
| D | 10.010 | 10.350 | 0.394 | 0.407 |
| E | 8.500 | 8.900 | 0.335 | 0.350 |
| E1 | 12.060 | 12.460 | 0.475 | 0.491 |
| е | e 2.540 TYP. | | 0.100 | TYP. |
| e1 | 4.980 | 5.180 | 0.196 | 0.204 |
| F | 2.590 | 2.890 | 0.102 | 0.114 |
| Н | 8.44 | 0 REF. | 0.332 | REF. |
| h | 0.000 | 0.300 | 0.000 | 0.012 |
| L | 13.400 | 13.800 | 0.528 | 0.543 |
| L1 | 3.560 | 3.960 | 0.140 | 0.156 |
| V | 6.060 REF. | | 0.239 | REF. |
| I | 6.60 | 0 REF. | 0.260 | REF. |
| Ф | 3.735 | 3.935 | 0.147 | 0.155 |



TO-220F Package Information



| O. mahad | Dimensions | In Millimeters | Dimension | s In Inches |
|----------|------------|----------------|-----------|-------------|
| Symbol | Min. | Max. | Min. | Max. |
| А | 4.300 | 4.700 | 0.169 | 0.185 |
| A1 | 1.300 | OREF | 0.051 | IREF |
| A2 | 2.800 | 3.200 | 0.110 | 0.126 |
| A3 | 2.500 | 2.900 | 0.098 | 0.114 |
| b | 0.500 | 0.750 | 0.020 | 0.030 |
| b1 | 1.100 | 1.350 | 0.043 | 0.053 |
| b2 | 1.500 | 1.750 | 0.059 | 0.069 |
| С | 0.500 | 0.750 | 0.020 | 0.030 |
| D | 9.960 | 10.360 | 0.392 | 0.408 |
| E | 14.800 | 15.200 | 0.583 | 0.598 |
| е | 2.540 |)TYP. | 0.100 |)TYP |
| F | 2.700 | OREF | 0.106 | BREF |
| Ф | 3.500 | OREF | 0.138 | BREF |
| h1 | 0.800 | OREF | 0.031 | IREF |
| h2 | 0.500REF | | 0.020 | REF |
| L | 28.000 | 28.400 | 1.102 | 1.118 |
| L1 | 1.700 | 1.900 | 0.067 | 0.075 |
| L2 | 1.900 | 2.100 | 0.075 | 0.083 |



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